onsemi

MOSFET – N-Channel, POWERTRENCH[®]

100 V

FDD3680

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable R_{DS(ON)} specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

Features

- 25 A, 100 V. $R_{DS(ON)} = 46 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$
 - $R_{DS(ON)} = 51 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low Gate Charge (38 nC Typical)
- Fast Switching Speed
- High Performance Trench Technology for Extremely Low R_{DS(ON)}
- High Power and Current Handling Capability

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-Source Voltage	100	V
V _{GSS}	Gate-Source Voltage	+20	V
I _D	Drain Current – Continuous (Note 1)	25	А
	Drain Current - Pulsed	100	
PD	Maximum Power Dissipation (Note 1)	68	W
	(Note 1a)	3.8	
	(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

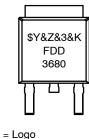
THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case (Note 1)	2.2	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1b)	96	°C/W

V _{DSS}	R _{DS(ON)} MAX	I _D MAX	
100 V	46 m Ω @ 10 V	25 A	



MARKING DIAGRAM

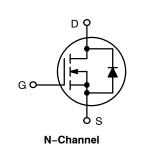


\$Y FDD3680 &Z

&З

&K

- = Device Code = Assembly Plant Code
- = 3-Digit Date Code Format
- = 2-Digits Lot Run Traceability Code



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
DRAIN-SC	DURCE AVALANCHE RATINGS (Note 1)					
W _{DSS}	Single Pulse Drain-Source Avalanche Energy	V _{DD} = 50 V, I _D = 6.1 A	-	-	245	mJ
I _{AR}	Maximum Drain-Source Avalanche Current		-	-	6.1	А
OFF CHAP	RACTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A	100	-	-	V
$\Delta {\rm BV}_{\rm DSS}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	-	101	-	mV/°C
ΔT_{J}						
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 80 V, V_{GS} = 0 V	-	-	10	μA
I _{GSSF}	Gate-Body Leakage, Forward	V_{GS} = 20 V, V_{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	V_{GS} = -20 V, V_{DS} = 0 V	-	-	-100	nA
ON CHAR	ACTERISTICS (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	2.4	4	V
$\Delta V_{GS(th)}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	-	-6.5	-	mV/°C
ΔT_{J}						
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.1 \text{ A}$	-	32	46	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 6.1 \text{ A}, T_J = 125^{\circ}\text{C}$ $V_{GS} = 6 \text{ V}, I_D = 5.8 \text{ A}$	-	61 34	92 51	
I _{D(on)}	On–State Drain Current	V _{GS} = 10 V, V _{DS} = 5 V	25	-	-	Α
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 6.1 A	_	25	-	S
DYNAMIC	CHARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 50 V, V_{GS} = 0 V, f = 1.0 MHz	-	1735	-	pF
C _{oss}	Output Capacitance		_	176	-	pF
C _{rss}	Reverse Transfer Capacitance		_	53	-	pF
SWITCHIN	IG CHARACTERISTICS (Note 2)					
t _{d(on)}	Turn–On Delay Time	V _{DD} = 50 V, I _D = 1 A, V _{GS} = 10 V,	-	14	25	ns
t _r	Turn–On Rise Time	R _{GEN} = 10 Ω	-	8.5	17	ns
t _{d(off)}	Turn–Off Delay Time		-	63	94	ns
t _f	Turn–Off Fall Time		-	21	34	ns
Qg	Total Gate Charge	V _{DS} = 50 V, I _D = 6.1 A, V _{GS} = 10 V	-	38	53	nC
Q _{gs}	Gate-Source Charge		-	8.1	-	nC
Q _{gd}	Gate–Drain Charge		-	9.2	-	nC
DRAIN-SC	DURCE DIODE CHARACTERISTICS AND MAXIM	UM RATINGS		•		
I _S	Maximum Continuous Drain-Source Diode Forwa	rd Current	_	-	2.9	Α
				1		1

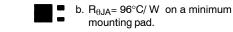
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



 V_{SD}

a. $R_{\theta JA}$ = 40°C/ W when mounted on a 1in² pad of 2oz copper.



 V_{GS} = 0 V, I_S = 2.9 A (Note 2)

0.73

1.3

V

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

Drain-Source Diode Forward Voltage

TYPICAL CHARACTERISTICS

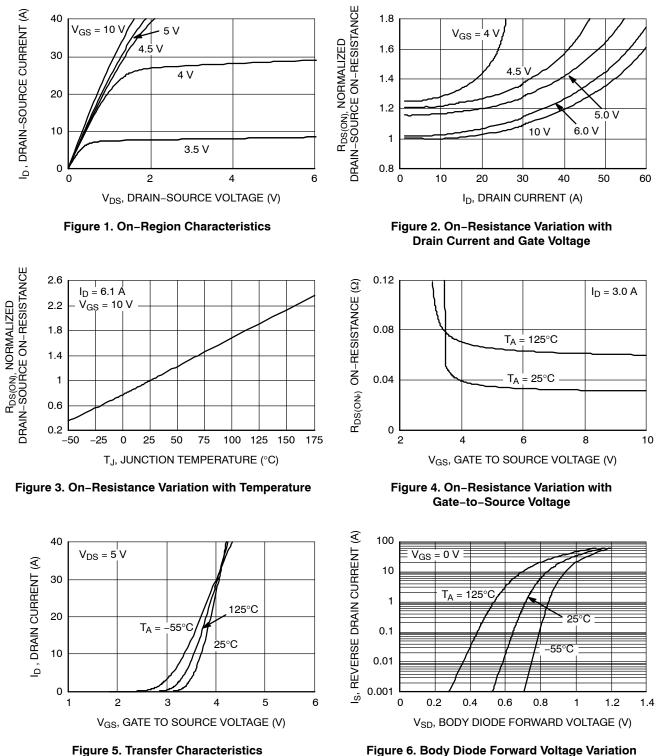


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

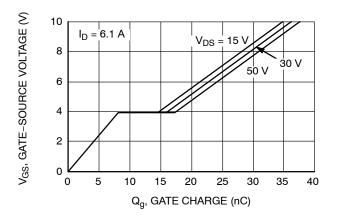


Figure 7. Gate Charge Characteristics

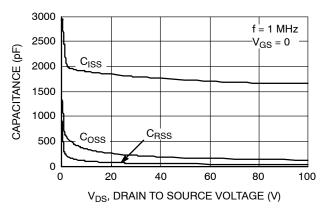


Figure 8. Capacitance Characteristics

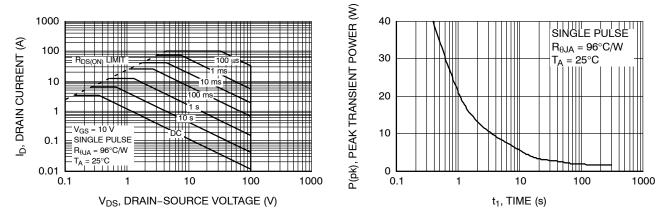
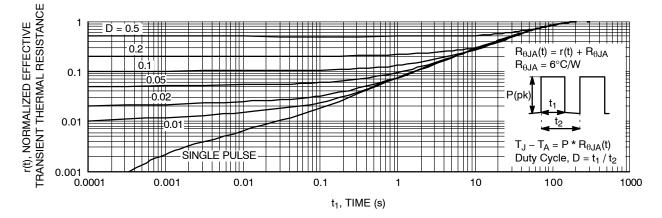
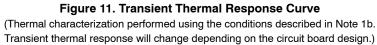


Figure 9. Maximum Safe Operating Area

Figure 10. Single Pulse Maximum Power Dissipation





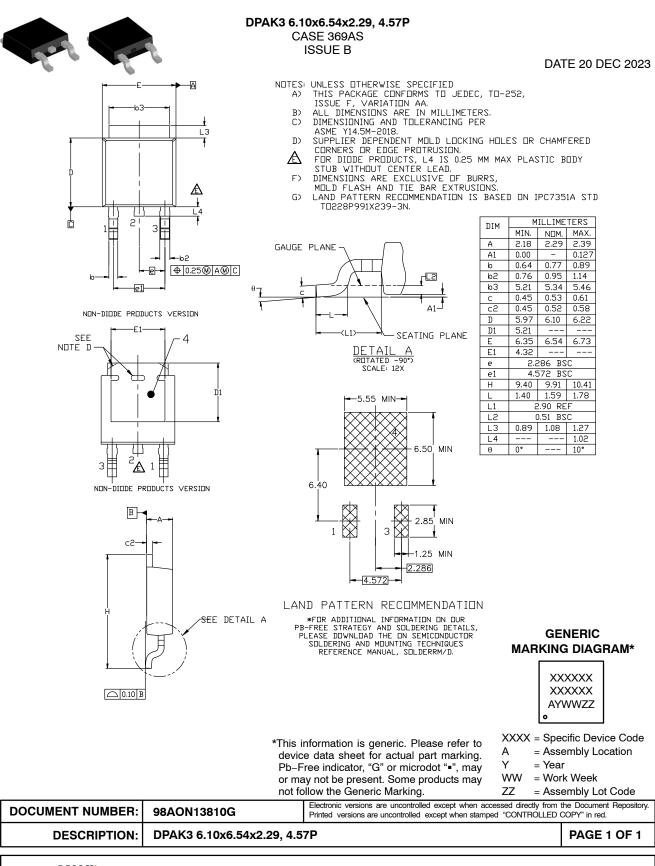
PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Shipping [†]
FDD3680	FDD3680	DPAK3 (TO-252 3 LD)	13"	16 mm	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

POWERTRENCH is registered trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

<u>onsemi.</u>



onsemi and ONSEMI: are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>